



深圳市蓝宝安科电子有限公司

Shenzhen LanbaoAnke Electronics Co.,Ltd.

承 认 书

APPROVAL SHEET

编号 NO.	LB-PTC-01
版次 Ver.	A/2

客户 Customer	
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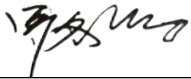
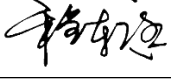
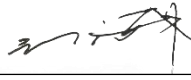
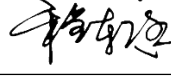
品名 Product	自恢复保险丝
系列 Series	1210

料号Part No.	规格描述Specification	备注Remark
蓝宝 LB fuse		
客 户 Customer		

供应商-蓝宝 Supplier-LB fuse	零件承认章 Approval Signet	客户 Customer	零件承认章 Approval Signet
制作 Make			
审查 Check			
批准 Approval			

联络Contact			
业务Sales	电话Telephone	手机Cellphone	邮箱E-mail
			lanbaofuse@163.com
零件承认后敬请回签一份给我司留存。			

History of Change变更记录

NO.	日期 Date	描述 Description	版次 Edition	修改 modified by	审核 Checked by
1	2022.09.18	新制订	A/1		
2	2023.04.03	更改为新封面	A/2		
3					
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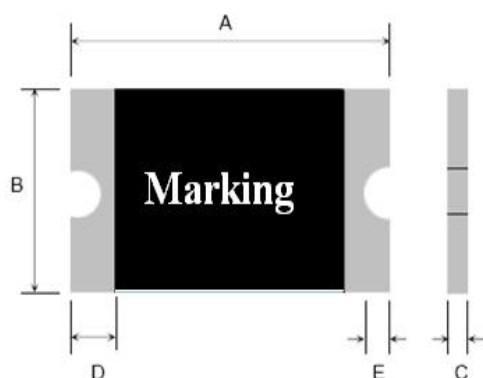
Surface Mountable PTC Resettable Fuse: LB-SMD1210 Series

Features:

- ✧ RoHS Compliant & Halogen Free
- ✧ faster tripping, 1210 Dimension, Surface mountable, Solid state
- ✧ Operation Current: 0.05A~2.00A
- ✧ Maximum Voltage: 6V~60Vdc
- ✧ Operating Temperature: -40℃ TO 85℃



Product Dimensions



Pig.1

Terminal pad materials :Tin-Plated Nickle-copper
Terminal pad solderability : Meets EIA specification
RS 186-9E and ANSI/J-STD-002 Category 3.

Unit : mm

Part Number	Marking	A		B		C		D	E
		Min	Max	Min	Max	Min	Max	Min	Min
LB-SMD1210-005	JZ	3.00	3.43	2.35	2.80	0.60	1.25	0.15	0.10
LB-SMD1210-010	JN	3.00	3.43	2.35	2.80	0.60	1.25	0.15	0.10
LB-SMD1210-020	JF	3.00	3.43	2.35	2.80	0.50	1.00	0.15	0.10
LB-SMD1210-030	JB	3.00	3.43	2.35	2.80	0.35	0.85	0.25	0.10
LB-SMD1210-035	JB	3.00	3.43	2.35	2.80	0.35	0.90	0.15	0.10
LB-SMD1210-035-30	JB	3.00	3.43	2.35	2.80	0.35	1.00	0.15	0.10
LB-SMD1210-050	JG	3.00	3.43	2.35	2.80	0.35	0.90	0.15	0.10
LB-SMD1210-050-30	JG	3.00	3.43	2.35	2.80	0.60	1.20	0.25	0.10
LB-SMD1210-075	JA	3.00	3.43	2.35	2.80	0.35	0.85	0.15	0.10
LB-SMD1210-075-16	JA	3.00	3.43	2.35	2.80	0.60	1.30	0.25	0.10
LB-SMD1210-075-24	JA	3.00	3.43	2.35	2.80	0.50	1.10	0.15	0.10
LB-SMD1210-100	JH	3.00	3.43	2.35	2.80	0.40	1.10	0.25	0.10
LB-SMD1210-110	LB	3.00	3.43	2.35	2.80	0.40	1.00	0.15	0.10
LB-SMD1210-110-12	LB	3.00	3.43	2.35	2.80	0.50	1.10	0.15	0.10
LB-SMD1210-110-16	LB	3.00	3.43	2.35	2.80	0.50	1.10	0.15	0.10

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Specifications are subject to change without notice !

LB-SMD1210-150	LB	3.00	3.43	2.35	2.80	0.60	1.40	0.15	0.10
LB-SMD1210-175	LB	3.00	3.43	2.35	2.80	0.60	1.50	0.15	0.10
LB-SMD1210-200	LB	3.00	3.43	2.35	2.80	0.60	1.50	0.15	0.10

Thermal Derating Chart-IH (A)

Part number	Maximum ambient operating temperatures (°C)								
	-40	-20	0	25	40	50	60	70	85
LB-SMD1210-005	0.08	0.07	0.06	0.05	0.04	0.04	0.03	0.03	0.02
LB-SMD1210-010	0.16	0.14	0.12	0.10	0.08	0.07	0.06	0.05	0.05
LB-SMD1210-020	0.29	0.26	0.22	0.20	0.16	0.14	0.13	0.11	0.08
LB-SMD1210-035	0.47	0.45	0.40	0.35	0.33	0.28	0.24	0.21	0.18
LB-SMD1210-035-30	0.47	0.45	0.40	0.35	0.33	0.28	0.24	0.21	0.18
LB-SMD1210-050	0.76	0.67	0.58	0.50	0.43	0.40	0.36	0.32	0.28
LB-SMD1210-050-30	0.76	0.67	0.58	0.50	0.43	0.40	0.36	0.32	0.28
LB-SMD1210-075	1.00	0.97	0.86	0.75	0.64	0.59	0.54	0.48	0.40
LB-SMD1210-075-24	1.00	0.97	0.86	0.75	0.64	0.59	0.54	0.48	0.40
LB-SMD1210-110	1.60	1.42	1.26	1.10	0.94	0.86	0.80	0.70	0.58
LB-SMD1210-110-12	1.60	1.42	1.26	1.10	0.94	0.86	0.80	0.70	0.58
LB-SMD1210-110-16	1.60	1.42	1.26	1.10	0.94	0.86	0.80	0.70	0.58
LB-SMD1210-150	2.30	2.02	1.76	1.50	1.24	1.11	1.00	0.85	0.65
LB-SMD1210-175	2.45	2.22	2.01	1.75	1.45	1.26	1.10	0.98	0.80
LB-SMD1210-200	2.60	2.44	2.35	2.00	1.78	1.67	1.50	1.45	1.10

Electrical Characteristic

Part Number	V _{max} (Vdc)	I _{max} (A)	I _{hold} (A)	I _{trip} (A)	P _d Max. (W)	Maximum time to trip		Resistance	
						Current (A)	Time (Sec)	R _{imin} (Ω)	R _{1max} (Ω)
LB-SMD1210-005	60	100	0.05	0.15	0.6	0.25	1.50	2.8	50
LB-SMD1210-010	60	100	0.10	0.30	0.6	0.50	0.60	0.8	15
LB-SMD1210-020	30	100	0.20	0.40	0.6	8.0	0.02	0.40	5
LB-SMD1210-030	24.0	100	0.30	0.75	0.6	8.0	0.20	0.40	2.5
LB-SMD1210-035-30	30	100	0.35	0.75	0.6	8.0	0.20	0.20	1.3
LB-SMD1210-035	16	100	0.35	0.75	0.6	8.0	0.20	0.20	1.3

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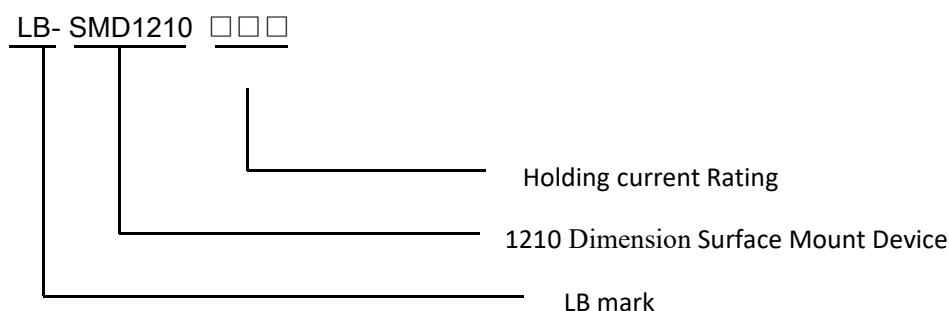
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LB-SMD1210-050	16	100	0.50	1.00	0.6	8.0	0.10	0.18	0.9
LB-SMD1210-050-30	30	100	0.50	1.00	0.6	8.0	0.10	0.180	0.9
LB-SMD1210-075	6	100	0.75	1.50	0.6	8.0	0.10	0.07	0.4
LB-SMD1210-075-16	16	100	0.75	1.50	0.6	8.0	0.10	0.07	0.45
LB-SMD1210-075-24	24	100	0.75	1.50	0.6	8.0	0.10	0.07	0.45
LB-SMD1210-100	12	100	1.00	2.00	0.6	8.0	0.30	0.05	0.27
LB-SMD1210-110	6	100	1.10	2.20	0.6	8.0	0.30	0.05	0.21
LB-SMD1210-110-12V	12	100	1.10	2.20	0.8	8.0	0.30	0.05	0.25
LB-SMD1210-110-12V	12	100	1.10	2.20	0.8	8.0	0.30	0.05	0.25
LB-SMD1210-150	6	100	1.50	3.00	0.8	8.0	0.50	0.03	0.11
LB-SMD1210-175	6	100	1.75	3.50	0.8	8.0	0.60	0.02	0.08
LB-SMD1210-200	6	100	2.00	4.00	0.8	8.0	1.00	0.015	0.07

Part Numbering System



Test Procedures And Requirements

Test	Test Conditions	Accept/Reject Criteria
Resistance	In still air @ 25℃	$R_{min} \leq R \leq R_{max}$
Time to Trip	Specified current, V_{max} , 25℃	$T \leq$ maximum Time to Trip
Hold Current	30min, at I_H	No trip
Trip Cycle Life	V_{max} , I_{max} , 100cycles	No arcing or burning
Trip Endurance	V_{max} , 1 hours	No arcing or burning

Physical Characteristics and Environmental Specifications

Physical Characteristics

Terminal materials :	Tin-Plated Nickle-copper
Soldering zone	Meets EIA specification RS 186-9E and ANSI/J-STD-002 Category 3.

Environmental Specifications		
Test	Conditions	Resistance Change
Passive aging	85°C,1000hours	±10%
Humidity aging	85°C/85%RH.168 hours	±5%
Thermal shock	MIL-STD-202,Method 107G +85°C/-40°C,20times	±33% typical resistance change
Solvent Resistance	MIL-STD-202,Method 215	no change
Vibration	ML-STD-883C,Test Condition A	No chage

Electrical Specifications:

I_{hold} = Hold Current. Maximum current device will not trip in 25°C still air.

I_{trip} = Trip Current. Minimum current at which the device will always trip in 25°C still air.

V_{max} = Maximum operating voltage device can withstand without damage at rated current (I_{max}).

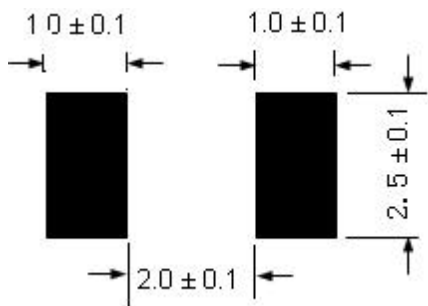
I_{max} = Maximum fault current device can withstand without damage at rated voltage (V_{max}).

P_d = Maximum power dissipation when device is in the tripped state in 25°C still air environment at rated voltage.

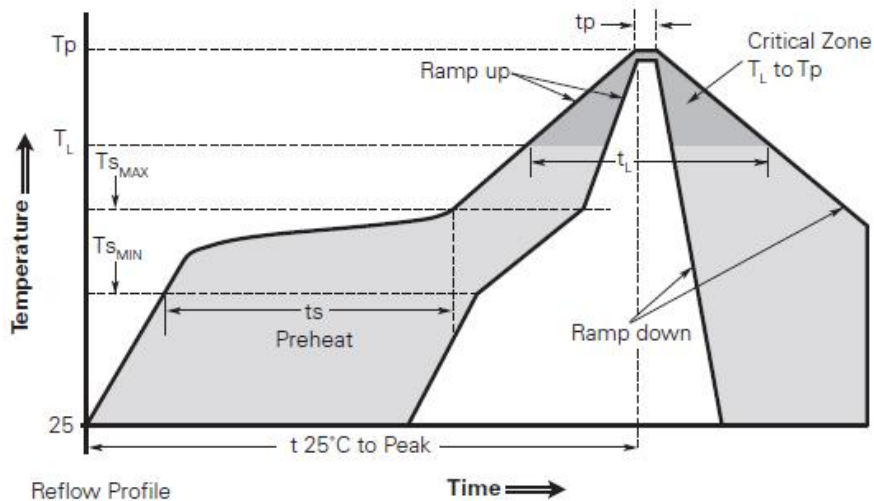
$R_{i_{min/max}}$ = Minimum/Maximum device resistance prior to tripping at 25°C.

$R_{l_{max}}$ = Maximum device resistance is measured one hour post reflow.

Recommended pad layout (mm)



Solder reflow conditions



Profile Feature	Pb-Free Assembly
Average ramp up rate (T_{S_MAX} to T_p)	3°C/second max.
Preheat	
• Temperature min. (T_{S_MIN})	150°C
• Temperature max. (T_{S_MAX})	200°C
• Time (t_{S_MIN} to t_{S_MAX})	60-120 seconds
Time maintained above:	
• Temperature (T_L)	217°C
• Time (t_L)	60-150 seconds
Peak/Classification temperature (T_p)	260°C
Time within 5°C of actual peak temperature	
Time (t_p)	30 seconds max.
Ramp down rate	3°C/second max.
Time 25°C to peak temperature	8 minutes max.

Note: All temperatures refer to topside of the package, measured on the package body surface.

- Recommended reflow methods: IR, vapor phase oven, hot air oven, N2 environment for lead-free.
- Devices are not designed to be wave soldered to the bottom side of the board.
- Recommended maximum paste thickness is 0.25mm (0.010inch).
- Devices can be cleaned using standard industry methods and solvents.
- Soldering temperature profile meets RoHs leadfree process.

Notes: If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements

Tape Specification And Reel Dimensions

Covering Specifications EIA 481-1(Unit:mm)	
W	8.0± 0.3
P ₀	4.0 ± 0.10
P ₁	4.0 ± 0.10
P ₂	2.0 ± 0.05
A ₀	2.87± 0.10

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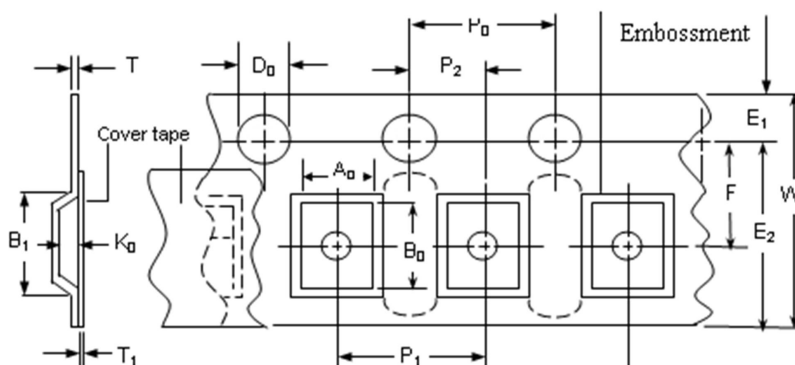
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EIA Reel Dimentions



B ₀	3.56± 0.10
D ₀	1.55 ± 0.05
F	3.5 0± 0.05
E ₁	1.75 ± 0.10
T	0.25 ± 0.10
Leader min.	390
Trailer min.	160
Reel Dimensions	
A	178±1.0
N	59±1
W ₁	8.5+1.0/-0.2
W ₂	12.0±1

EIA Tape Component Dimentions



Packaging Quantity

Part number	Quantity	Part number	Quantity
LB-SMD1210-005	4000	LB-SMD1210-075	4000
LB-SMD1210-010	4000	LB-SMD1210-075-24	4000
LB-SMD1210-020	4000	SMD1210-110	4000
LB-SMD1210-035-30V	4000	SMD1210-110-12	4000
LB-SMD1210-035	4000	SMD1210-110-16	4000
LB-SMD1210-050	4000	SMD1210-150	4000
SMD1210-175	3000/4000	SMD1210-200	3000/4000

Storage

The maximum ambient temperature shall not exceed 38℃. Storage temperatures higher than 38℃ could result in the deformation of packaging materials. The maximum relative humidity recommended for storage is 60%. High humidity with high temperature can accelerate the oxidation of the solder plating on the termination and reduce the solderability of the components. Sealed plastic bags with desiccant shall be used to reduce the oxidation of the termination and shall only be opened prior to use. The products shall not be stored in areas where harmful gases containing sulfur or chlorine are present

WARNING

- Use PPTC beyond the maximum ratings or improper use may result in device damage and possible electrical arcing and flame.
- PPTC are intended for protection against occasional over current or over temperature fault conditions and should not be used when repeated fault conditions or prolonged trip events are anticipated.
- Device performance can be impacted negatively if devices are handled in a manner inconsistent with recommended electronic, thermal, and mechanical procedures for electronic components.
- Use PPTC with a large inductance in circuit will generate a circuit voltage ($L di/dt$) above the rated voltage of the PPTC.
- Avoid impact PPTC device its thermal expansion like placed under pressure or installed in limited space.
- Contamination of the PPTC material with certain silicon based oils or some aggressive solvents can adversely impact the performance of the devices. PPTC SMD can be cleaned by standard methods.
- Requests that customers comply with our recommended solder pad layouts and recommended reflow profile. Improper board layouts or reflow profile could negatively impact solderability performance of our devices.

Notes

The specification is intended to present application, product and technical data to assist the user in selecting PPTC circuit production devices. However, users should independently evaluate and test the suitability of each product. LB makes no warranties as to the accuracy or completeness of the information and disclaims any liability resulting from its use. LB's only obligations are those in the LB Standard Terms and Conditions of Sale and in no case will LB be liable for any incidental, indirect, or consequential damages arising from the sale, resale, or misuse of its products. LB reserves the right to change or update, without notice, any information contained in this specification.